



IFW/S

Attorney Docket No. 5649-1138

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re: Chung et al.
Serial No.: 10/634,168
Filed: August 5, 2003
For: METHODS OF FABRICATING CONTACTS FOR SEMICONDUCTOR
DEVICES UTILIZING A PREFLOW PROCESS

Examiner: Michael K. Luhrs
Conf. No.: 6337
Art Unit: 2824

Date: March 4, 2005

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Applicants provide the present Amendment to address the issues raised in the Official Action mailed December 14, 2004.

It is not believed that any fee is associated with the present response other than those provided for in any accompanying documents. However, the Commissioner is hereby authorized to charge any additional fee that may be required or credit any refund to our Deposit Account No. 50-0220. Any additional fee or credit may be charged to our Deposit Account No. 50-0220.

Amendments to the Specification begin on page 2 of this paper.

Amendment to the Claims are reflected in the Listing of Claims that begins on page 3 of this paper.

Remarks begin on page 6 of this paper.